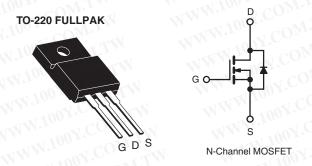


Vishay Siliconix

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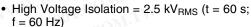
### Power MOSFE

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	100				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.16			
Q <sub>g</sub> (Max.) (nC)	33				
Q <sub>gs</sub> (nC)	5.4				
Q <sub>gd</sub> (nC)	15				
Configuration	Single				



#### **FEATURES**

Isolated Package





RoHS COMPLIANT

- Sink to Lead Creepage Distance = 4.8 mm
- 175 °C Operating Temperature
- Dynamic dV/dt Rating
- · Low Thermal Resistance
- · Lead (Pb)-free Available

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, low on-resistance and ruggedized device design, cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	ONITH WILLIAM TW
Package	TO-220 FULLPAK
Lord (Dh) fine	IRFI530GPbF
Lead (Pb)-free	SiHFI530G-E3
Carlla W. W. Co. T. W. W. Co.	IRFI530G
SnPb	SiHFI530G

<b>ABSOLUTE MAXIMUM RATINGS</b> T	<sub>C</sub> = 25 °C, u	nless otherw	ise noted			
PARAMETER	WWW	· SV.CO	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	W.14.		V <sub>DS</sub>	100	COMP	
Gate-Source Voltage		$V_{GS}$	± 20	VII		
Continuous Drain Current	V +10V	T <sub>C</sub> = 25 °C	TW	9.7	CAM	
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	6.9		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	39		
Linear Derating Factor		CO TY	0.28	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	100	mJ		
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	9.7	A A	
Repetitive Avalanche Energy <sup>a</sup>	TV	MM	E <sub>AR</sub>	4.2	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		$P_{D}$	42	W	
Peak Diode Recovery dV/dt <sup>c</sup>		dV/dt	5.5	V/ns		
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for	10 s	·100	300 <sup>d</sup>	With	
Mounting Torque	6.22 or N	C 00 av M0 agravi		10	lbf ⋅ in	
	6-32 or M3 screw		A. CO	TW1.1	N · m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). WWW.100X.COM.TW
- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 1.6 \,\text{mH}$ ,  $R_G = 25 \,\Omega$ ,  $I_{AS} = 9.7 \,\text{A}$  (see fig. 12).
- c.  $I_{SD} \le 9.7$  A,  $dI/dt \le 140$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFI530G, SiHFI530G

# Vishay Siliconix



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THERMAL RESISTANCE RA	ATINGS	WW 100Y	COMITY	
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	WW.	65	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	A TWW.I	3.6	C/VV

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UN
Static	YOUN.Co.	WTI	MALLIONICO	VIII			
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		100	N -	-	٧
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		$O_{M_1}$	0.12	-	V/°
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		2.0	- XN	4.0	٧
Gate-Source Leakage	I <sub>GSS</sub>	OMITH	$V_{GS} = \pm 20 \text{ V}$	MOD	7.	± 100	n,
Zero Gate Voltage Drain Current	Inco OOY	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V			1.7.1	25	μΑ
Zero date Voltage Brain Guirent	I <sub>DSS</sub>	$V_{DS} = 80 \text{ V}$	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C		T	250	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 5.8 A <sup>b</sup>		ov-Cc		0.16	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 5.8 A <sup>b</sup>		4.0	$O_{M_{I}}$	W -	S
Dynamic	W. W.	On r. COM	WW.	100	$CO_{Mr}$	-XX	
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		700 7.	670	7.	pF
Output Capacitance	C <sub>oss</sub>			11907	250	TIN	
Reverse Transfer Capacitance	C <sub>rss</sub>			100	60	TEW	
Drain to Sink Capacitance	C			10	12		
Total Gate Charge	$Q_g$	M. Joseph	OM.	MA	. C	33	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 9.7 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	WW.	-57 (	5.4	
Gate-Drain Charge	$Q_{gd}$	1007	COMPANIENT TO	- TW	100.	_ 15	
Turn-On Delay Time	t <sub>d(on)</sub>	100	I.Com.TW	N.	8.6	MOD	TV
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, I_D = 9.7 \text{ A}, \\ R_G = 12 \Omega, R_D = 5.1 \Omega, \\ \text{see fig. } 10^b$		Min	28		ns
Turn-Off Delay Time	t <sub>d(off)</sub>				34	Y.CO	
Fall Time	t <sub>f</sub>			-111	25	ON-CC	
Internal Drain Inductance	$L_D$	Between lead, 6 mm (0.25") from package and center of die contact		- 11	4.5	100 <sup>-7</sup> 1.C	nH
Internal Source Inductance	Ls			-	7.5	1007	
Drain-Source Body Diode Characteristic	s OM-		M. John J. COM.	ĺ	TATAN'	W.Inc	<b>V</b>
Continuous Source-Drain Diode Current	COIs	MOSFET symbol showing the integral reverse p - n junction diode		N -	-WV	9.7	00X
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			W -	-11	39	
Body Diode Voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C}, \ I_S = 9.7  \text{A}, \ V_{GS} = 0  \text{V}^b$			- 1	2.5	10
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 9.7 A, dl/dt = 100 A/μs <sup>b</sup>		WT	150	280	n
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			- āvN	0.85	1.7	μ
Forward Turn-On Time	t <sub>on</sub>	Intrinsic t	urn-on time is negligible (turn	on is dor	ninated b	y L <sub>S</sub> and I	L <sub>D</sub> )

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %. WWW.100Y.COM.TW



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

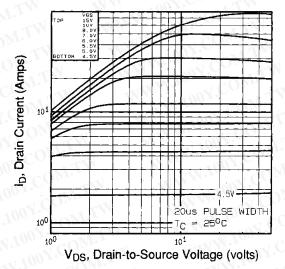


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

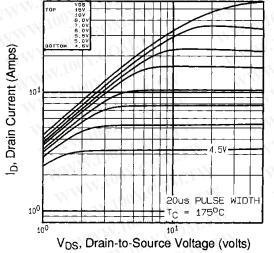


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C

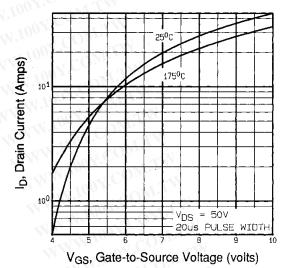


Fig. 3 - Typical Transfer Characteristics

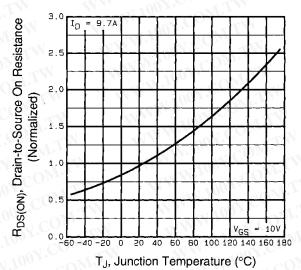


Fig. 4 - Normalized On-Resistance vs. Temperature

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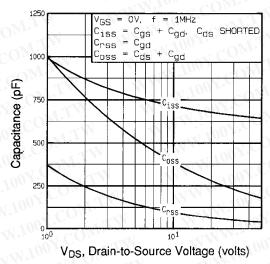


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

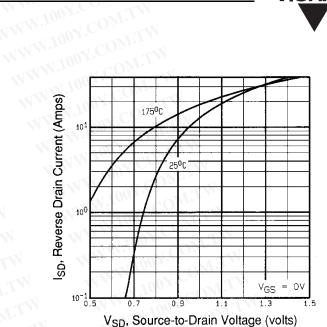


Fig. 7 - Typical Source-Drain Diode Forward Voltage

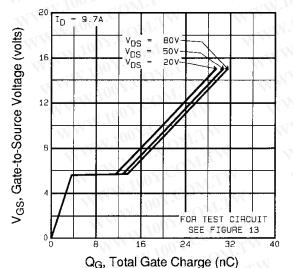


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

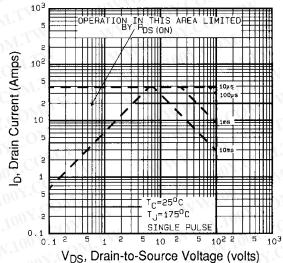


Fig. 5 - Fig. 8 - Maximum Safe Operating Area





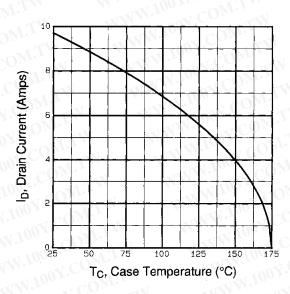


Fig. 9 - Maximum Drain Current vs. Case Temperature

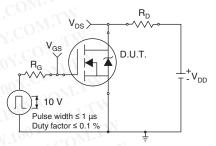


Fig. 10a - Switching Time Test Circuit

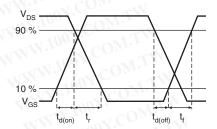


Fig. 10b - Switching Time Waveforms

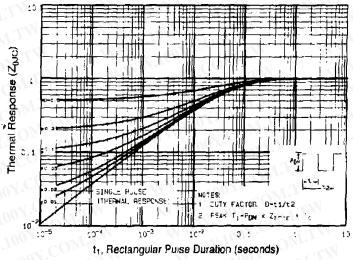


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

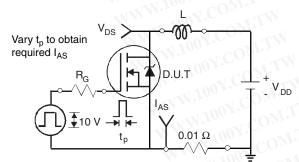


Fig. 12a - Unclamped Inductive Test Circuit

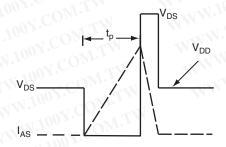
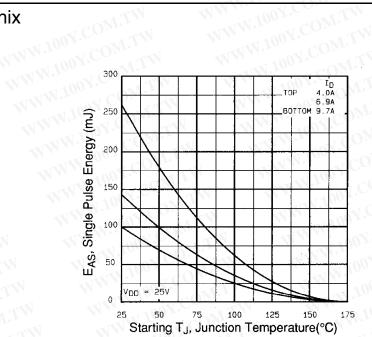


Fig. 12b - Unclamped Inductive Waveforms

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Fig. 12c - Maximum Avalanche Energy vs. Drain Current

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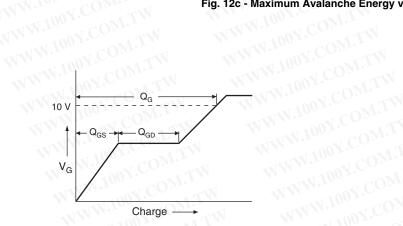
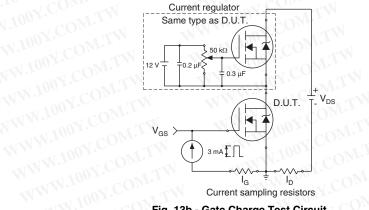


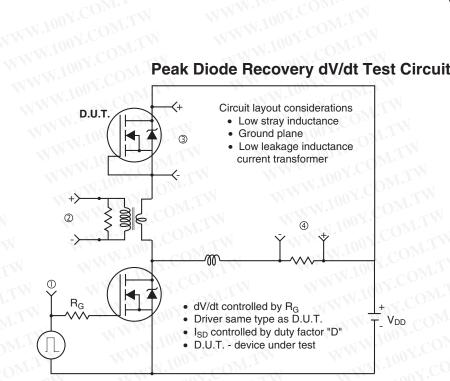
Fig. 13a - Basic Gate Charge Waveform WWW.100Y.COM



WWW.100Y.COM.TW Fig. 13b - Gate Charge Test Circuit WWW.100Y.COM



#### Peak Diode Recovery dV/dt Test Circuit



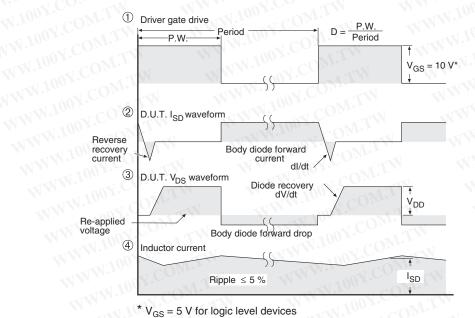


Fig.14 - For N-Channel

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